







SOIC footprint on the front

TSSOP footprint on the back

#### 1. Description

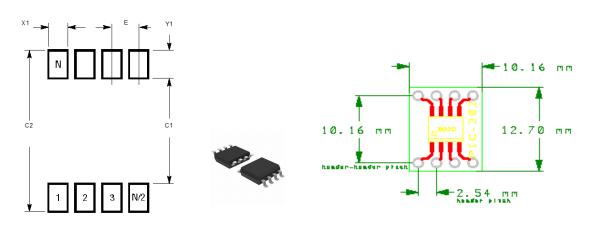
SMT adaptor for your prototyping needs. This multi-adaptor board footprints are designed for mounting SOIC-8 TSSOP-8 SMD IC component, converting them to a convenient pin spacing of 2.54mm pitch. PIC-202 SMD IC test adaptor is definitely handy for your prototyping needs.

#### 2. Features

- 1. Convert SMD pins to header pins 2.54mm pitch (100mil or 0.1 inch)
- 2. PCB board size 12.7mm x 10.2mm x 1.6mm
- 3. Soldering pad for
  - SOIC-8 pins (pitch 1.27mm)
  - TSSOP 8 pins (pitch 0.65mm)

# 3. Mechanical Dimension Top Side

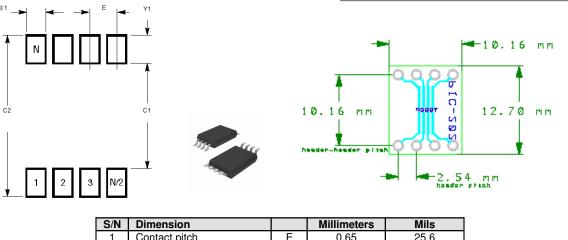
S/N	SMD type	Pin	Pitch
1	SOIC-8	8	1.27mm



S/N	Dimension		Millimeters	Mils
1	Contact pitch	E	1.27	50.0
2	Contact pad spacing	C1	4.00	157.5
3	Contact pad spacing	C2	6.80	267.7
4	Contact pad width (X44)	X1	0.60	23.6
5	Contact pad length (X44)	Y1	1.40	55.1
6	Distance between pads	G	0.67	26.4

# **Bottom Side**

S/N	SMD type	Pin	Pitch
1	TSSOP-8	8	0.65mm



S/N	Dimension		Millimeters	Mils
1	Contact pitch	Е	0.65	25.6
2	Contact pad spacing	C1	0.81	31.9
3	Contact pad spacing	C2	6.81	268.1
4	Contact pad width (X44)	X1	0.30	11.8
5	Contact pad length (X44)	Y1	3.00	118.1
6	Distance between pads	G	0.34	13.4

### 4. Specifications & Features





